

**SURFACE MOUNT
GLASS PASSIVATED SILICON RECTIFIER
VOLTAGE 600 Volts CURRENT 3.0 Amperes**

FEATURES

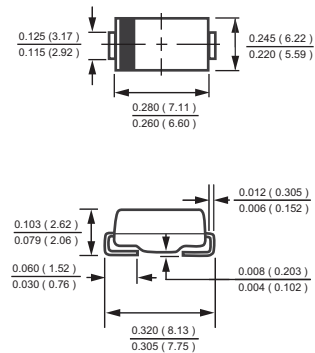
- * Glass passivated device
- * Ideal for surface mounted applications
- * Low leakage current
- * Metallurgically bonded construction
- * Mounting position: Any
- * Weight: 0.24 gram

MECHANICAL DATA

- * Epoxy : Device has UL flammability classification 94V-0
- * MSL: 1 Level



SMC



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
resistive or inductive load.

MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	FM305-W	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	600	Volts
Maximum RMS Voltage	V_{RMS}	420	Volts
Maximum DC Blocking Voltage	V_{DC}	600	Volts
Maximum Average Forward Rectified Current at Ambient Temperature	I_O	3.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	150	Amps
Typical Current Squared Time	i^2T	93.3	A ² S
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	47	°C/W
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$	13	°C/W
Typical Junction Capacitance (Note 2)	C_J	30	pF
Operating Temperature Range	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to + 150	°C

ELECTRICAL CHARACTERISTICS (@TA=25 °C unless otherwise noted)

CHARACTERISTICS	SYMBOL	FM305-W	UNITS
Maximum Instantaneous Forward Voltage at 3.0A DC	V_F	1.0	Volts
Maximum Average Reverse Current at Rated DC Blocking Voltage	@ $T_A = 25^\circ\text{C}$	1.0	μA
	@ $T_A = 100^\circ\text{C}$	50	μA

- NOTES : 1. Thermal Resistance :Mounted on PCB.
 2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
 3. "Fully ROHS compliant", "100% Sn plating (Pb-free)".
 4. Available in Halogen-free epoxy by adding suffix -HF after the part nbr.

2014-11
REV: A

RATING AND CHARACTERISTICS CURVES (FM305-W)

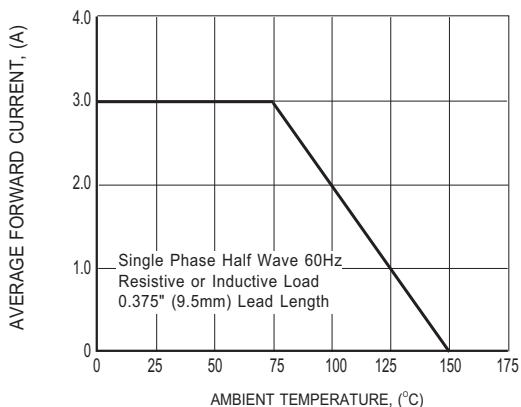


FIG.1 TYPICAL FORWARD CURRENT DERATING CURVE

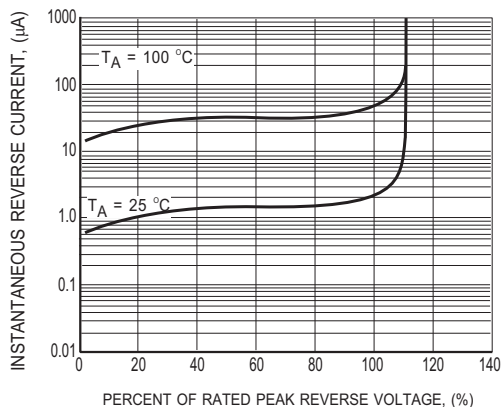


FIG.2 TYPICAL REVERSE CHARACTERISTICS

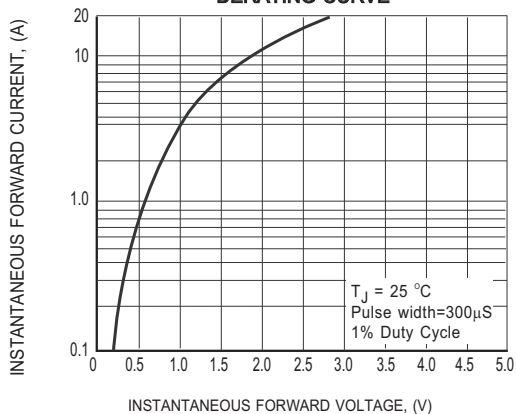


FIG.3 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

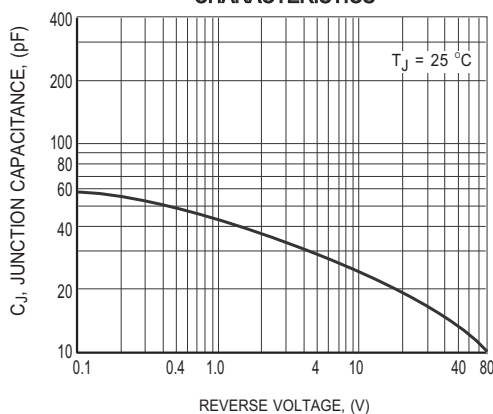


FIG.4 TYPICAL JUNCTION CAPACITANCE

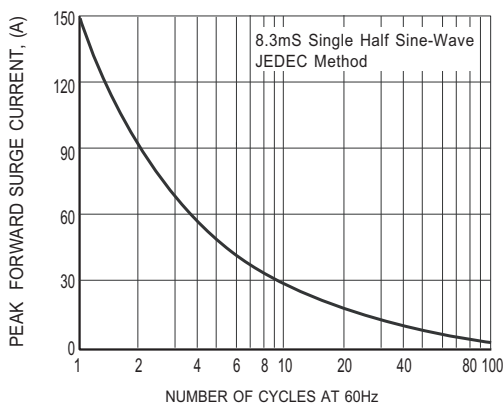
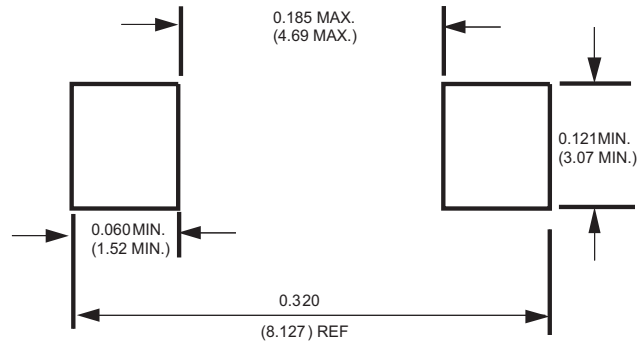


FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



Mounting Pad Layout



Dimensions in inches and (millimeters)



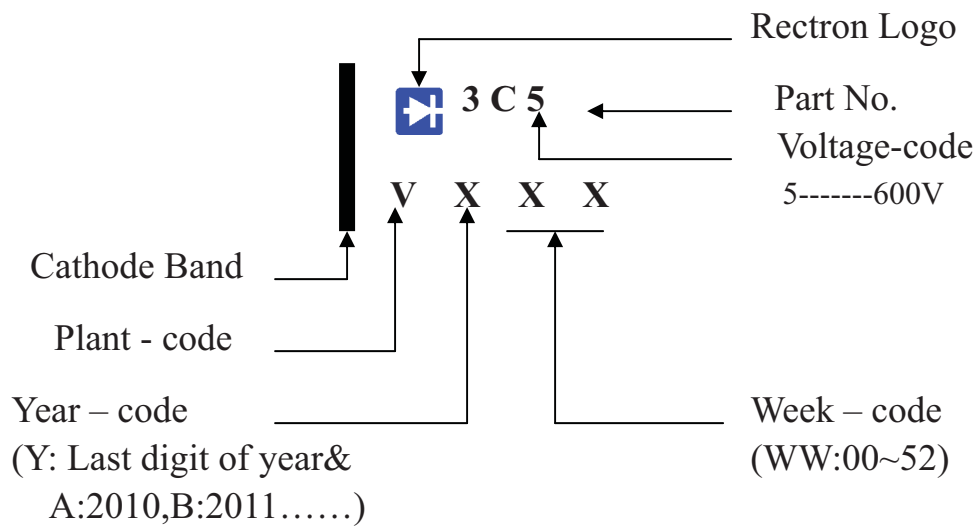


Attachment information about FM305-W

1. Internal Circuit



2. Marking on the body



REEL TAPING SPECIFICATIONS FOR SURFACE MOUNT DEVICES-FLAT MELF (SMA/SMB/SMC)

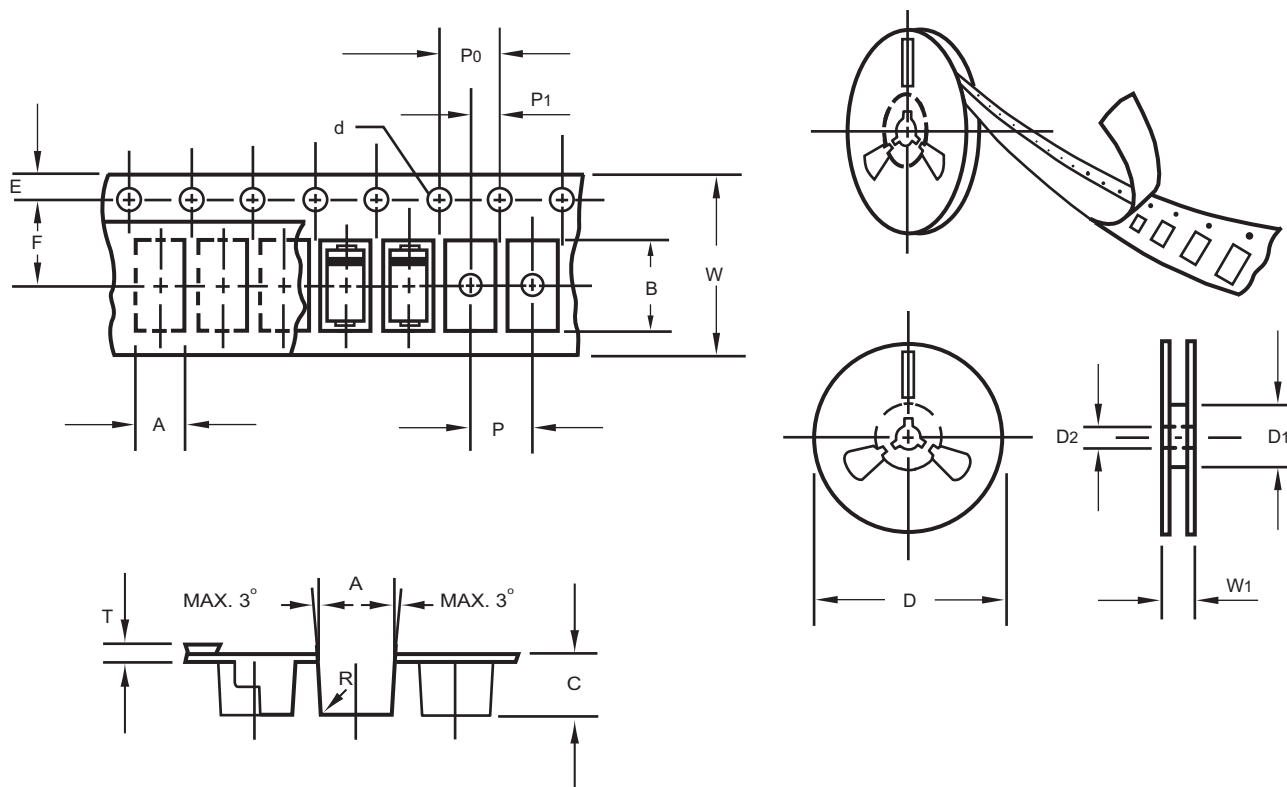


Fig.: Configuration of FLAT MELF TAPING
(SMA/SMB/SMC)

ITEM	SYMBOL	DO214AC (SMA) mm(inch)	DO214AA (SMB) mm(inch)	DO214AB (SMC) mm(inch)
Carrier width	A	2.6 ± 0.15 (.102 ± .006)	3.65 ± 0.1 (.144 ± .004)	6.0 ± 0.1 (.236 ± .004)
Carrier length	B	5.15 ± 0.15 (.203 ± .006)	5.69 ± 0.1 (.224 ± .004)	8.30 ± 0.1 (.327 ± .004)
Carrier depth	C	2.3 ± 0.15 (.091 ± .006)	2.67 ± 0.1 (.105 ± .004)	2.5 ± 0.1 (.098 ± .004)
Sprocket hole	d	1.5 ± 0.1 (.059 ± .004)	1.5 ± 0.1 (.059 ± .004)	1.5 ± 0.1 (.059 ± .004)
Reel outside diameter	D	178 ± 2.0 (7.0 ± .079)	178 ± 2.0 (7.0 ± .079)	178 ± 2.0 (7.0 ± .079)
Reel inner diameter	D1	50 Min.	50 Min.	50 Min.
Feed hole diameter	D2	13 ± 0.5 (.512 ± .020)	13 ± 0.5 (.512 ± .020)	13 ± 0.5 (.512 ± .020)
Sprocket hole position	E	1.5 ± 0.1 (.059 ± .004)	1.5 ± 0.1 (.059 ± .004)	1.5 ± 0.1 (.059 ± .004)
Punch hole position	F	5.65 ± 0.05 (.222 ± .002)	5.65 ± 0.05 (.222 ± .002)	7.65 ± 0.05 (.301 ± .002)
Punch hole pitch	P	4.0 ± 0.1 (.157 ± .004)	8.0 ± 0.1 (.315 ± .004)	8.0 ± 0.1 (.315 ± .004)
Sprocket hole pitch	P0	4.0 ± 0.1 (.157 ± .004)	4.0 ± 0.1 (.157 ± .004)	4.0 ± 0.1 (.157 ± .004)
Embossment center	P1	2.0 ± 0.1 (.079 ± .004)	2.0 ± 0.1 (.079 ± .004)	4.0 ± 0.1 (.157 ± .004)
Total tape thickness	T	0.30 ± .05 (.012 ± .002)	0.6 Max.	0.6 Max.
Tape width	W	12.0 ± 0.2 (.472 ± .008)	12.0 ± 0.2 (.472 ± .008)	16.0 ± 0.2 (.630 ± .008)
Reel width	W1	16.8 ± 2.0 (.661 ± .079)	16.8 ± 2.0 (.661 ± .079)	24.0 ± 2.0 (.945 ± .079)

Notes: 1.Devices are packed in accordance with EIA standard RS-481-A and specification given above.
2.Available on 7 inch (1500 ct.) or 13 inch (5000 ct.) diameter reels.

PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SMC	-W	3,000	3,000	---	---	330	360*355*360	24,000	11.50

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